

PRODUCT/PROCESS CHANGE NOTIFICATION

PCN APM-DIS/09/4358 Notification Date 02/16/2009

APM - ASD & IPAD Division

Protection, Rectifiers, IPAD and AC Switches in SOT/SOD packages

Conversion to ECOPACK(r)2 "Halogen-free" Grade

Table 1. Change Implementation Schedule

Forecasted implementation date for change	20-Feb-2009
Forecasted availabillity date of samples for customer	09-Feb-2009
Forecasted date for STMicroelectronics change Qualification Plan results availability	09-Feb-2009
Estimated date of changed product first shipment	18-May-2009

Table 2. Change Identification

Product Identification (Product Family/Commercial Product)	Protection, Rectif, IPAD & ACSwitches in SOT/Dx23
Type of change	Package assembly material change
Reason for change	Production rationalization
Description of the change	The purpose of this change is to meet the so called "Halogen-Free" requirements of the market through the implementation of the ECOPACK(r)2 program. The ECOPACK(r)2 grade is defined as follows: 1. RoHS compliant, including with its exemptions, 2. 500 ppm maximum of Antimony as oxide or organic compound in each organic assembly materials (glue, substrate, mold compounds, housing). 3. 900ppm maximum of [Bromine + Chlorine], this value referring to the maximum total content.
Product Line(s) and/or Part Number(s)	See attached
Description of the Qualification Plan	See attached
Change Product Identification	labeling, product marking and QA number
Manufacturing Location(s)	

47/.

				_	_	_	
Тэ	hla	2	lict	Λf	Attac	hment	0
	DIE	J.	LISL	OI.	Allac		-

Customer Part numbers list	
Qualification Plan results	

PCN APM-DIS/09/4358
Notification Date 02/16/2009
Name:
Title:
Company:
Date:
Signature:

47/.

DOCUMENT APPROVAL

Name	Function
Paris, Eric	Division Marketing Manager
Duclos, Franck	Division Product Manager
Cazaubon, Guy	Division Q.A. Manager

A7/.



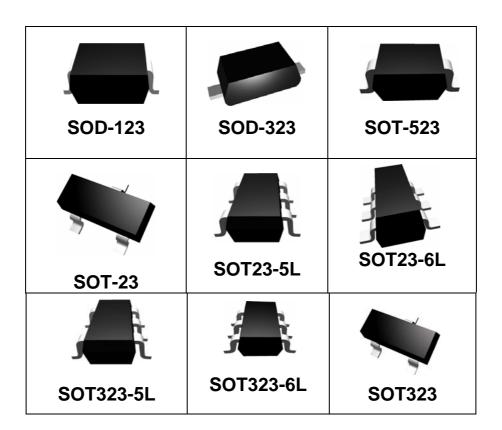
PRODUCT/PROCESS CHANGE NOTIFICATION

PCN APM-DIS/09/4358

APM - ASD & IPAD Division¹

Protection, Rectifiers, IPAD and AC Switches in SOT/SOD packages:

Conversion to ECOPACK®2 "Halogen-free" Grade



(1) APM: Analog, Power & MEMS Group - ASD: Application Specific Device - IPAD: Integrated Passive and Active Devices

February 2009 5

WHY THIS CHANGE?

The purpose of this change is to meet the so called "Halogen-Free" requirements of the market through the implementation of the ECOPACK®2 program.

The ECOPACK®2 grade is defined as follows:

- 1. RoHS compliant, including with its exemptions,
- 2. **500 ppm** maximum of **Antimony** as oxide or organic compound in each organic assembly materials (glue, substrate, mold compounds, housing).
- 3. **900ppm** maximum of [Bromine + Chlorine], this value referring to the maximum total content.

WHAT IS THE CHANGE?

ST ECOPACK®2 specification includes the suppression of halogenated substances when currently used in the moulding compound, and their replacement by new moulding compounds.

Additionally, ECOPACK®2 products include the compliance to the ST banned substances list.

All P/N series involved in this change are listed below.

Product Sub-Family	Product Series	Packages
AC Switches	P0102AL 5AA4 P0102BL 5AA4 P0109AL 5AA4 SMDB3	
Protection	DSL01-0xxSC5 ESDA14V2xxxx ESDA25x ESDA5V3xxx ESDA6V1xxxx ESDLIN1524BJ	SOD-123 SOD-323 SOD-523 SOT23-3L
Rectifiers	BARxxxxFILM BASxxxxFILM BATxxxxFILM	SOT23-5L SOT323-3L
IPAD	USBxxxxW5 USBxxxxW6 USBxxxxP6	

The use of the **Halogen free** moulding compound will **not impact** the **electrical**, **dimensional** and **thermal** parameters, maintaining unchanged current information published on the relevant datasheets. The verification is included in the qualification program.

The devices produced with the new moulding compound comply with the **UL 94 V-0 standard**.

(*) Restriction of the use of certain Hazardous Substances

HOW AND WHEN?

Qualification and test results:

The **reliability test plan** supporting the **qualification program** for the halogen-free moulding compound is provided in **appendix 1**.

The qualification report is available on request **now**.

Sampling:

For all the concerned Products Families, **samples of selected devices**, including the test vehicles, are available **on request as indicated below**.

Salestypes	Package	Availability
P0102AL 5AA4	SOT23-3L	
BAT20JFILM	SOD323	
BAT30KFILM	SOT523	
BAT41JFILM	SOD323	
BAT41KFILM	SOT523	
BAT46ZFILM	SOD123	
BAT54KFILM	SOT523	Now
ESDA5V3L	SOT23-3L	
BAT54JFILM	SOD323	
BAT30CWFILM	SOT323	
BAT54CWFILM	SOT323	
BAT54SWFILM	SOT323	
BAT46FILM	SOT23-3L	

Other samples are available on request for delivery within notice period if ordered within 30 days from notification.

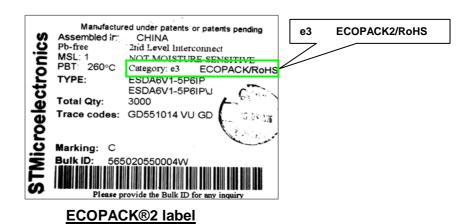
Change implementation schedule:

The **production start** and **first shipments** will be implemented according to our work in progress and materials availability as indicated in the schedule below:

Salestypes	Production Start	1st Shipments
ALL	From Week 08-2009	From Week 19-2009

Lack of acknowledgement of the PCN within **30 days** will constitute acceptance of the change. After acknowledgement, lack of additional response within the **90 day** period will constitute acceptance of the change (Jedec Standard No. 46-C). In any case, **first shipments** may start earlier with customer's **written agreement**.

Traceability:



More information on the adopted marking and labelling is available in Information Letter # CRP/08/4251 issued on Dec.23rd, 2008.

The **traceability** is mainly ensured by the **labeling**, the **product marking** when space on the component body allows it, and by the **Q.A. number**.

Appendix 1: Reliability tests for qualification program of change

Protection, Rectifiers, IPAD and AC Switches in SOT/SOD packages: Conversion to ECOPACK®2 "Halogen-free" Grade

Reliability tests of QUALIFICATION PROGRAM

Test vehicles (*)	Product Family	
STPS0520Z		
BAT41KFILM	Rectifiers	
BAT46FILM		
ESDA6V1W5		
ESDA6V1-5W6	Protection	
DALC208SC6		
P0102AL-5AA4	AC Switches	

QUALIFICATION TESTS					
TEST	CONDITIONS	DURATION	NBR OF LOTS (**)	SAMPLE SIZE	ACCEPTANCE CRITERIA
Parametric verification	Data sheet specification	Not applicable	3	30 pcs / lot	Datasheet
Pressure Cooker Test JESD22-A102	121°C 2 atm. 100%RH	96 Hrs	6	77 pcs / lot	0 failure
Temperature Humidity Bias JESD22 A101	Tamb = 85°C RH = 85% VR = 0.8 x VRRM or 100V max	1000 hours	6	77 pcs / lot	0 failure
High Temperature Reverse Bias JESD22-A108	VR = 0.8 x VRRM Tj = Tjmax or 100V max	1000 hours	4	77 pcs / lot	0 failure
Construction analysis	Random samples, 3 lots Insulated, 3 lots non Insulated	Not applicable	3	5 pcs	Assembly rules
Physical dimension JESD22 B100	As per package dimensions & tolerances	Not applicable	1	30 pcs	0 failure
Resistance to Solder Heat JESD22B-106-A	2 oil dipping 260°C 10s ON / 15s OFF		3	30 pcs/lot	0 failure
Solderability SnPb & SnAgCu JESD22-B102D	Dry ageing 16hrs / 220°C & 245°C – 5 sec dip. Steam aging 8hrs / 220°C & 245°C – 5 sec dip.	Not applicable	4	15 pcs / lot	0 failure

^(*) selected as per structural similarity procedures according to AEC-Q101

^(**) Lots selected among test vehicles of the list above.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time. without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners

© 2009 STMicroelectronics - All rights reserved.

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morroco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

